SiHB15N60E



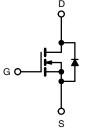


E Series Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.28				
Q _g max. (nC)	78					
Q _{gs} (nC)	9					
Q _{gd} (nC)	17					
Configuration	Single					

D²PAK (TO-263)





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION					
Package	D ² PAK (TO-263)				
Lead (Pb)-free and Halogen-free	SiHB15N60E-GE3				

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	LIMIT	UNIT					
Drain-Source Voltage			V _{DS}	600	V			
Gate-Source Voltage	V _{GS}	V _{GS} ± 30						
Continuous Drain Current (T 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	15				
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C		9.6	А			
Pulsed Drain Current ^a		I _{DM}						
Linear Derating Factor		1.4	W/°C					
Single Pulse Avalanche Energy ^b		E _{AS}	102	mJ				
Maximum Power Dissipation	PD	180	W					
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C					
Drain-Source Voltage Slope	dV/dt	70	1//20					
Reverse Diode dV/dt ^d		7.7	V/ns					
Soldering Recommendations (Peak temperature) ^c		300	°C					

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 11.6 mH, R_g = 25 Ω , I_{AS} = 4.2 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D, \, dI/dt = 100$ A/µs, starting $T_J = 25 \ ^\circ C.$

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PARAMETER	SYMBOL	TYP.	MA	X.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	6	2				
Maximum Junction-to-Case (Drain)	R _{thJC}	-	- 0.7			°C/W		
		1			I			
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	1	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					1	L	1	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, I _D = 1 mA	-	0.71	-	V/°C	
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	: V _{GS} , I _D = 250 μΑ	2	-	4	V	
			$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	-	± 1	μA	
Zara Cata Valtaga Drain Current		V _{DS} =	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 480 V	′, V _{GS} = 0 V, T _J = 125 °C	; _	-	10	μA	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 8 A	-	0.23	0.28	Ω	
Forward Transconductance	g _{fs}	V _{DS}	= 30 V, I _D = 8 A	-	4.6	-	S	
Dynamic		-			*	•	•	
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	1350	-		
Output Capacitance	C _{oss}		-	70	-	pF		
Reverse Transfer Capacitance	C _{rss}		-	5	-			
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	53		-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	v _{DS} = 0 v	-	177	-			
Total Gate Charge	Qg			-	39	78	nC	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 8 A, V_{DS} = 480 V$	v -	11	-		
Gate-Drain Charge	Q _{gd}			-	17	-		
Turn-On Delay Time	t _{d(on)}			-	16	32		
Rise Time	t _r	Vpp	= 480 V, I _D = 8 A,	-	26	52	ns	
Turn-Off Delay Time	t _{d(off)}		$= 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$	-	41	82		
Fall Time	t _f			-	22	44]	
Gate Input Resistance	R _g	f = 1	0.3	0.86	1.7	Ω		
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the		-	15	A	
Pulsed Diode Forward Current	I _{SM}	U U	integral reverse			60		
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 8 A, V _{GS} = 0 V	-	1.0	1.2	V	
Reverse Recovery Time	t _{rr}			-	302	604	ns	
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	-	4.0	8	μC		
Reverse Recovery Current	I _{RRM}	u/ut =	100 A/µs, V _R = 25 V	-	24	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

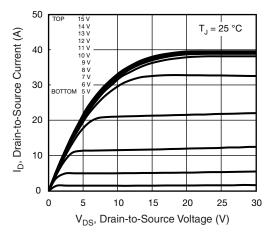


Fig. 1 - Typical Output Characteristics

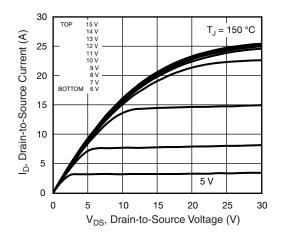


Fig. 2 - Typical Output Characteristics

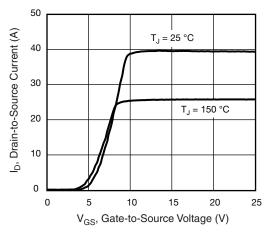


Fig. 3 - Typical Transfer Characteristics

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Fig. 4 - Normalized On-Resistance vs. Temperature

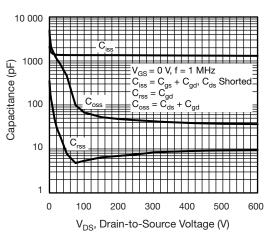


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

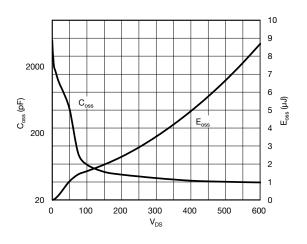


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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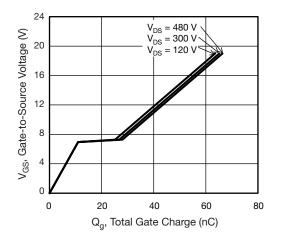


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

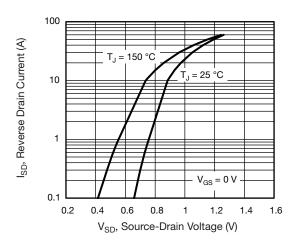


Fig. 8 - Typical Source-Drain Diode Forward Voltage

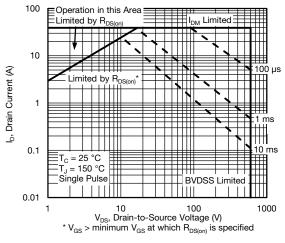


Fig. 9 - Maximum Safe Operating Area

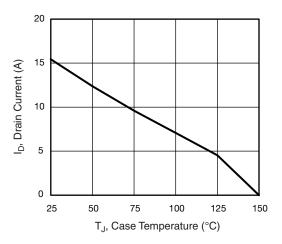


Fig. 10 - Maximum Drain Current vs. Case Temperature

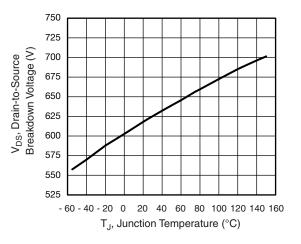
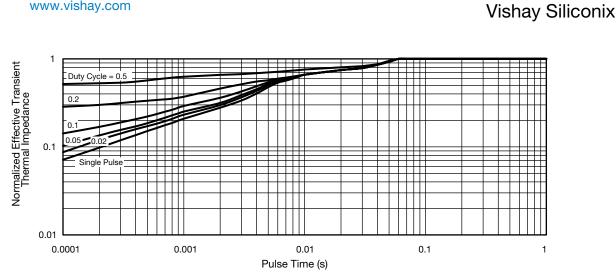


Fig. 11 - Temperature vs. Drain-to-Source Voltage

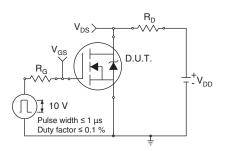
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Fig. 13 - Switching Time Test Circuit

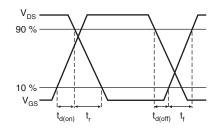


Fig. 14 - Switching Time Waveforms

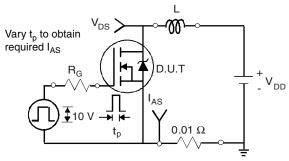
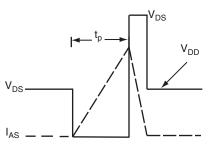


Fig. 15 - Unclamped Inductive Test Circuit



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Fig. 16 - Unclamped Inductive Waveforms

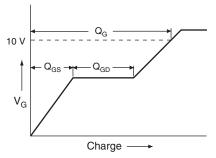
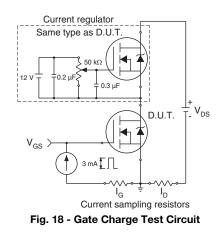


Fig. 17 - Basic Gate Charge Waveform



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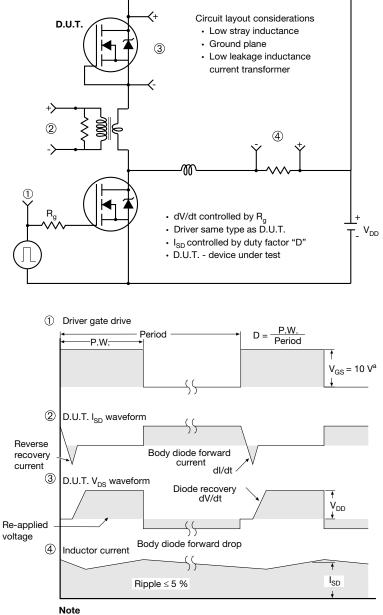
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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Package Information

H

B

A1

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° tọ 8°

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Seating plane

TO-263AB (HIGH VOLTAGE)

3 /4

A

н

∕5∖

Detail A

(Datum A)

D

<u>4</u> Lī

$2 \times b^{2}$ $2 \times b^{2}$ $2 \times b^{2}$ $4 \oplus 0.010 \otimes A \otimes B $ $ / \pm 0.004 \otimes B $ $ A \oplus A = 0$ $ A \oplus A = 0$										
	MILLIMETERS INCHES				MILLIMETERS		INCHES			
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.420
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b1	0.51	0.89	0.020	0.035		е	2.54 BSC 0.100) BSC	
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.625
b3	1.14	1.73	0.045	0.068		L	1.78	2.79	0.070	0.110
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066
c1	0.38	0.58	0.015	0.023		L2	-	1.78	-	0.070
c2	1.14	1.65	0.045	0.065		L3	0.25	BSC	0.010) BSC
D	8.38	9.65	0.330	0.380		L4	4.78	5.28	0.188	0.208
ECN: S-82 DWG: 597	110-Rev. A, 1)	15-Sep-08								

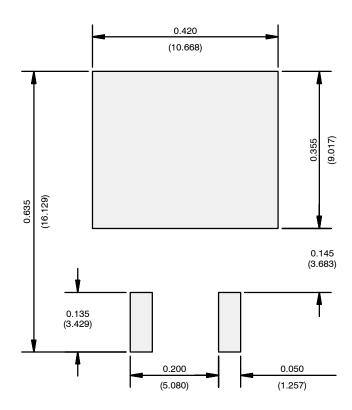
Α

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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